

# HRV103A

# Silicon Schottky Barrier Diode for Rectifying

REJ03G0398-0100 Rev.1.00 Oct 12, 2004

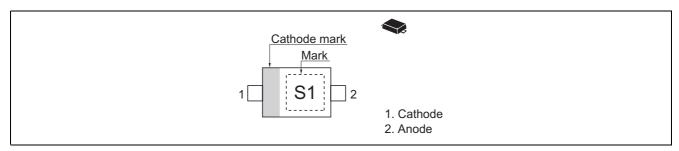
### **Features**

- Low forward voltage drop and suitable for high efficiency rectifying.
- Thin Ultra small Resin Package (TURP) is suitable for high density surface mounting and high speed assembly.

## **Ordering Information**

Type No.	Laser Mark	Package Code
HRV103A	S1	TURP

## **Pin Arrangement**



## **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Value	Unit
Repetitive peak reverse voltage	V <sub>RRM</sub>	30	V
Reverse voltage	V <sub>R</sub>	30	V
Average rectified current	lo *2	1	А
Non-Repetitive peak forward surge current	I <sub>FSM</sub> * <sup>1</sup>	5	А
Junction temperature	Tj	125	°C
Storage temperature	Tstg	−55 to +125	°C

Notes: 1. 10ms sine wave 1 pulse

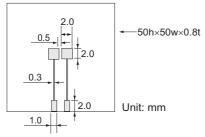
2. Ta = 44°C, With Ceramics board (board size: 50mm  $\times$  50 mm, Land size 2mm  $\times$  2 mm) Short form wave ( $\theta$ 180°C), VR = 10 V.

### **Electrical Characteristics**

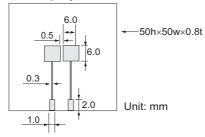
 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Min	Тур	Max	Unit	Test Condition
Forward voltage	V <sub>F1</sub>	_	_	0.27	V	I <sub>F</sub> = 100 mA
	$V_{F2}$	_	_	0.36		I <sub>F</sub> = 700 mA
	$V_{F3}$	_	_	0.42		I <sub>F</sub> = 1 A,
Reverse current	I <sub>R1</sub>	_	_	100	μΑ	V <sub>R</sub> = 5 V
	I <sub>R2</sub>	_	_	1000		V <sub>R</sub> = 30 V
Capacitance	С	_	_	40	pF	V <sub>R</sub> = 10 V, f = 1 MHz
Thermal resistance	Rth(j-a)	_	100	_	°C/W	Ceramics board *1
		_	200			Glass epoxy board *2

Notes: 1. Ceramics board



### 2. Glass epoxy board



3. TURP is the structure which radiates heat to a substrate, please perform mounting to a substrate by reflow.

### **Main Characteristics**

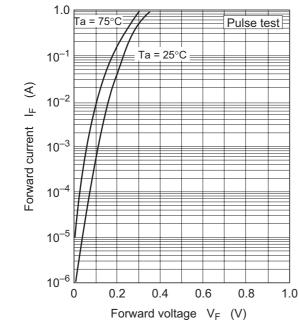


Fig.1 Forward current vs. Forward voltage

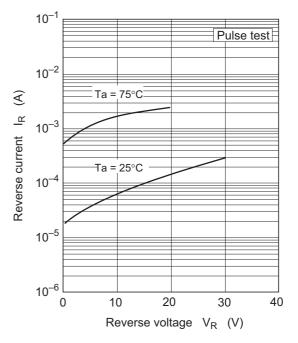
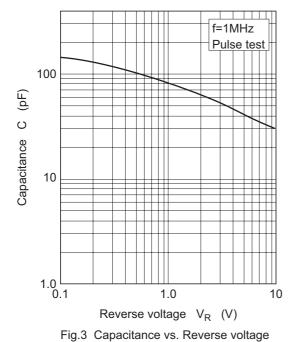
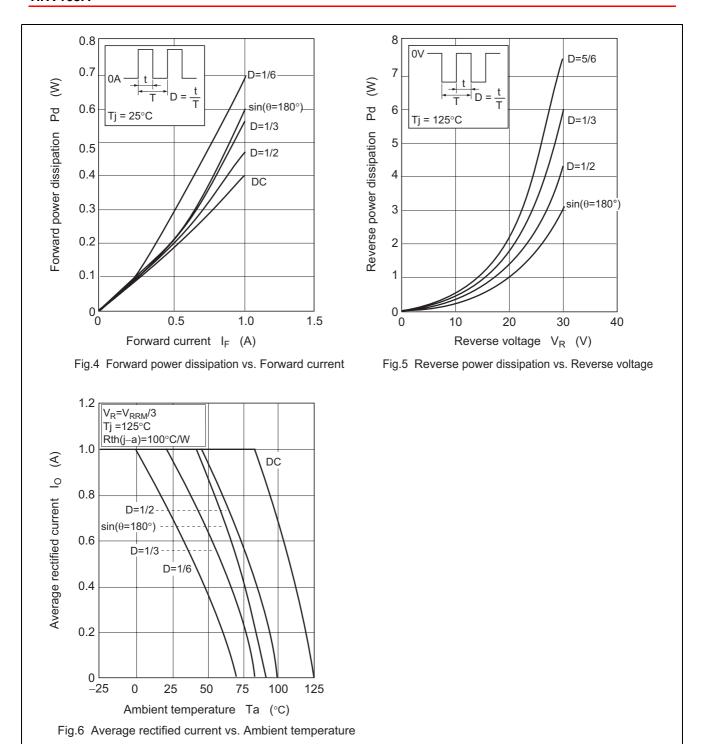
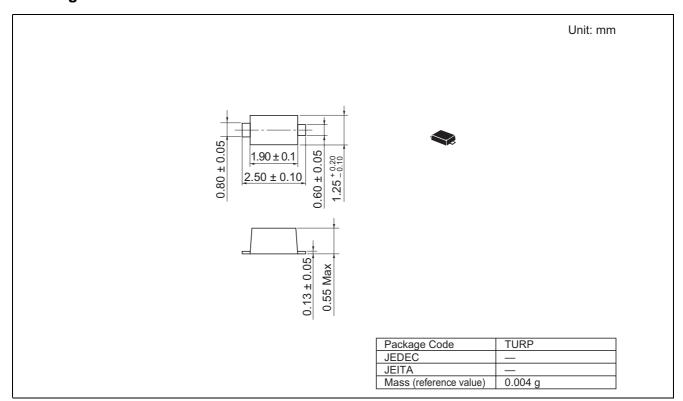


Fig.2 Reverse current vs. Reverse voltage





## **Package Dimensions**



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